



## **Module Specification**

### **Materials for Semiconductors**

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## Part 1: Information

**Module title:** Materials for Semiconductors

**Module code:** UFMFFR-30-3

**Level:** Level 6

**For implementation from:** 2023-24

**UWE credit rating:** 30

**ECTS credit rating:** 15

**Faculty:** Faculty of Environment & Technology

**Department:** FET Dept of Engineering Design & Mathematics

**Partner institutions:** None

**Field:** Engineering, Design and Mathematics

**Module type:** Module

**Pre-requisites:** None

**Excluded combinations:** None

**Co-requisites:** None

**Continuing professional development:** No

**Professional, statutory or regulatory body requirements:** None

## Part 2: Description

**Overview:** Not applicable

**Features:** Not applicable

**Educational aims:** This module will cover the different properties (electrical, optical, and magnetic) of electronic materials in relation to their importance in the semiconductor industry and their technological applications such as wafer devices, solid-state fuel cells, lithium secondary batteries, light-emitting diodes and solid-state

lasers. This will include semiconductors, electronic ceramics, conducting polymers and optical and magnetic materials. This module will also cover processes and operations in semiconductor manufacturing.

**Outline syllabus:** Indicative Content:

Material Science Concepts

Electrical and thermal Conduction of Solids

Modern theory of solids

Semiconductors electronic ceramics and polymers.

Dielectric materials and Insulation

Magnetic properties of materials

Optical properties of materials

Superconductivity

Processes in Semiconductor Manufacturing

### **Part 3: Teaching and learning methods**

**Teaching and learning methods:** Teaching will include the formal presentation of material through lectures, and presentations by the teaching team. The delivery is intended to ensure that students have opportunity to develop the theoretical understanding of different materials and their properties suitable for semiconductor device fabrication. The student will apply this understanding to the develop processing technologies for novel semiconductor devices and that this will form the module assessment.

Independent learning includes hours engaged with essential reading, assignment preparation and completion etc.

**Module Learning outcomes:** On successful completion of this module students will achieve the following learning outcomes.

**MO1** Describe in detail the fundamental properties of electronic materials and their roles and applications in modern semiconductor device manufacturing technology.

**MO2** Analyse the fundamental principles underlying the design and operation of various electronic devices.

**MO3** Develop manufacturing processes for novel semiconductor devices selecting suitable semiconductor materials in the electronics industry.

**MO4** Compare and critically appraise the processes and operations involved in semiconductor manufacturing technology.

**Hours to be allocated:** 300

**Contact hours:**

Independent study/self-guided study = 46 hours

Placement = 56 hours

Face-to-face learning = 48 hours

Total = 150

**Reading list:** The reading list for this module can be accessed at [readinglists.uwe.ac.uk](https://uwe.rl.talis.com/modules/ufmffr-30-3.html) via the following link <https://uwe.rl.talis.com/modules/ufmffr-30-3.html>

## Part 4: Assessment

**Assessment strategy:** The assessment for this module is as follows:

**REPORT:** The report will involve students undertaking an investigation of the application of semiconductor materials relating to processes, applications or specific devices in industry. The activity will result in a group report involving groups of 2 or 3 students. Individual contributions will be determined via a peer review process.

**PRESENTATION:** The presentation will involve a short presentation on the group report. Each student will be marked individually based on their contribution and the knowledge on the technical content covered.

Resit is the same as the first sit

Resit deliverable(s) will be scaled appropriately to group size and task complexity

**Assessment tasks:**

**Report (First Sit)**

Description: Group report

Weighting: 75 %

Final assessment: Yes

Group work: Yes

Learning outcomes tested: MO1, MO2, MO3, MO4

**Presentation (First Sit)**

Description: A group presentation

Weighting: 25 %

Final assessment: No

Group work: Yes

Learning outcomes tested: MO1, MO2

**Report (Resit)**

Description: Group report

Resit deliverable(s) will be scaled appropriately to group size and task complexity

Weighting: 75 %

Final assessment: Yes

Group work: Yes

Learning outcomes tested: MO1, MO2, MO3, MO4

**Presentation (Resit)**

Description: A group presentation

Resit deliverable(s) will be scaled appropriately to group size and task complexity

Weighting: 25 %

Final assessment: No

Group work: Yes

Learning outcomes tested: MO1, MO2

### **Part 5: Contributes towards**

This module contributes towards the following programmes of study:

Mechanical Engineering (Mechatronics) [AustonSingapore] BEng (Hons) 2023-24

Electrical and Electronic Engineering [AustonSingapore] BEng (Hons) 2023-24